

High Voltage LED Series Chip on Board

LC013D



High efficacy COB LED package
well-suited for use in spotlight applications

Features & Benefits

- Chip on Board (COB) solution makes it easy to design in
- Simple assembly reduces manufacturing cost
- Low thermal resistance
- InGaN/GaN MQW LED with long time reliability

Applications

- Spotlight / Downlight
- LED Retrofit Bulbs
- Outdoor Illumination



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1. Characteristics

a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	T_a	-40 ~ +105	°C	-
Storage Temperature	T_{stg}	-40 ~ +120	°C	-
LED Junction Temperature	T_J	140	°C	-
Case Temperature	T_c	105	°C	-
Forward Current	I_F	920	mA	-
Power Dissipation	P_D	34.5	W	-
ESD (HBM)	-	±2	kV	-
ESD (MM)	-	±0.5	kV	-

b) Electro-optical Characteristics ($I_F = 360$ mA, $T_J = 85$ °C)

Item	Unit	Rank	Min.	Typ.	Max.
Forward Voltage (V_F)	V	YZ	31.8	34.6	37.5
Color Rendering Index (R_a)	-	5	80	-	-
		7	90	-	-
Thermal Resistance (junction to chip point)	°C/W		-	1.4	-
Beam Angle	°		-	115	-
Nominal Power	W			13.5	

Notes:

- 1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature ($T_J = T_C = T_a = 85$ °C)
- 2) Samsung maintains measurement tolerance of: forward voltage = ±5 %, CRI = ±1
- 3) Refer to the derating curve, '3. Typical Characteristics Graph' designed within the range.

c) Luminous Flux Characteristics ($I_F = 360 \text{ mA}$)

CRI (R _a) Min.	Nominal CCT (K)	Flux Rank	Flux @ T _J = 85 °C (lm)		
			Min.	Typ.	Max.
80	2700	H5	1510	1589	-
		D1	1589	1669	-
	3000	H5	1589	1673	-
		D1	1673	1757	-
	3500	H6	1639	1725	-
		D1	1725	1812	-
	4000	H6	1669	1757	-
		D1	1757	1844	-
	5000	H6	1684	1772	-
		D1	1772	1861	-
	5700	H6	1684	1772	-
		D1	1772	1861	-
	6500	H6	1659	1746	-
		D1	1746	1834	-

CRI (R _a) Min.	Nominal CCT (K)	Flux Rank	Flux @ T _J = 85 °C (lm)		
			Min.	Typ.	Max.
90	2700	H2	1291	1359	-
		D1	1359	1427	-
	3000	H3	1352	1423	-
		D1	1423	1494	-
	3500	H4	1400	1473	-
		D1	1473	1547	-
	4000	H4	1429	1505	-
		D1	1505	1580	-
	5000	H4	1433	1508	-
		D1	1508	1584	-

Notes:

- 1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature ($T_J = T_C = 85 \text{ °C}$).
- 2) Samsung maintains measurement tolerance of: Luminous flux = $\pm 7 \%$, CRI = ± 1

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	P	H	W	H	A	H	D	N	D	2	5	Y	Z	W	3	H	5

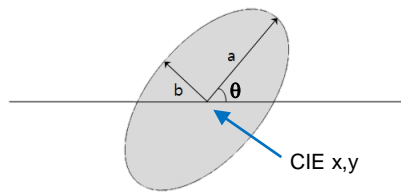
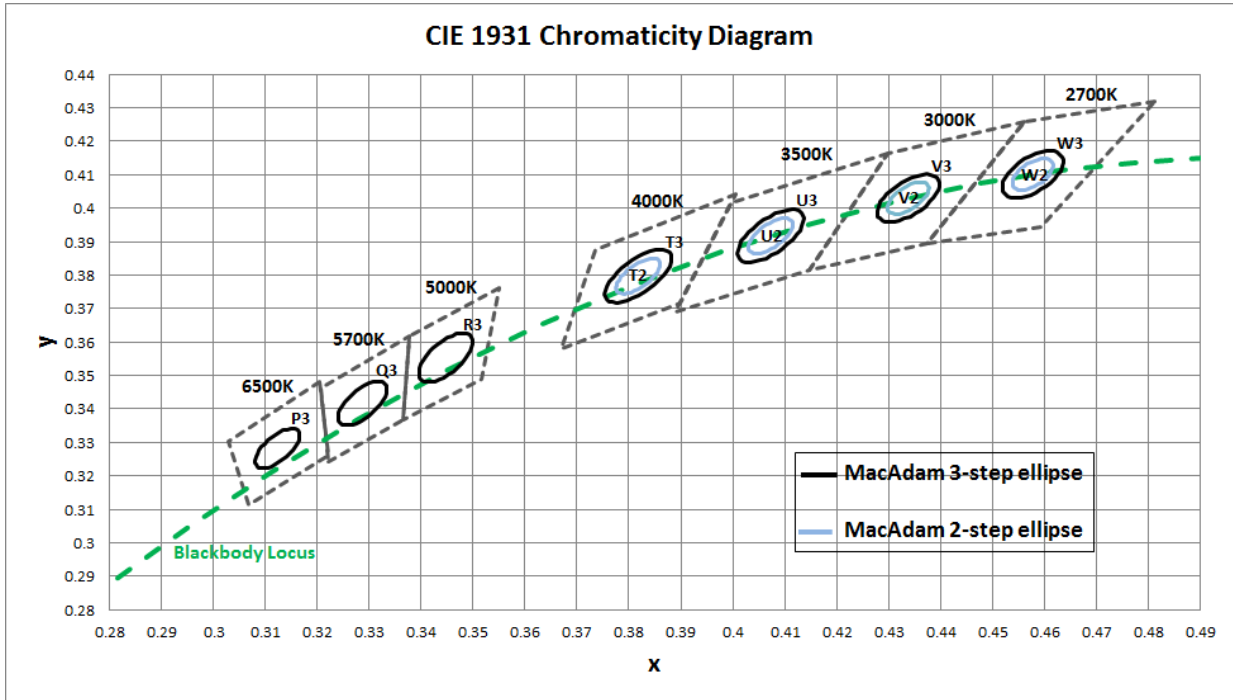
Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	WH	White
6	Product Version	A	
7 8	Form Factor	HD	COB
9	Lens Type	N	No lens
10	Wattage or Model	D	LC013D
11	Internal Code	2	
12	CRI & Sorting Temperature	5 7	Min. 80 (85°C) Min. 90 (85°C)
13 14	Forward Voltage (V)	YZ	31.8~37.5
15	CCT (K)	W V U T R Q P	2700K 3000K 3500K 4000K 5000K 5700K 6500K
16	MacAdam Step	2 3	MacAdam 2-step MacAdam 3-step
17 18	Luminous Flux (Lm)	H2 H3 H4 H5 H6 D1	Min. 1200 Min. 1300 Min. 1400 Min. 1500 Min. 1600 Add rank

a) Binning Structure ($I_f = 360 \text{ mA}$, $T_J = 85 \text{ }^\circ\text{C}$)

CRI (Ra) Min.	Nominal CCT (K)	Product Code	V _f Rank	Color Rank	Flux Rank	Flux Range (Φ _v , lm)
80	2700	SPHWWAHDND25YZW2H5	YZ	W2	H5	1510 ~
		SPHWWAHDND25YZW3H5		W3		
		SPHWWAHDND25YZW2D1		W2	D1	1589 ~
		SPHWWAHDND25YZW3D1		W3		
	3000	SPHWWAHDND25YZV2H5	YZ	V2	H5	1589 ~
		SPHWWAHDND25YZV3H5		V3		
		SPHWWAHDND25YZV2D1		V2	D1	1673 ~
		SPHWWAHDND25YZV3D1		V3		
	3500	SPHWWAHDND25YZU2H6	YZ	U2	H6	1639 ~
		SPHWWAHDND25YZU3H6		U3		
		SPHWWAHDND25YZU2D1		U2	D1	1725 ~
		SPHWWAHDND25YZU3D1		U3		
	4000	SPHWWAHDND25YZT2H6	YZ	T2	H6	1669 ~
		SPHWWAHDND25YZT3H6		T3		
		SPHWWAHDND25YZT2D1		T2	D1	1757 ~
		SPHWWAHDND25YZT3D1		T3		
	5000	SPHWWAHDND25YZR3H6	YZ	R3	H6	1684 ~
		SPHWWAHDND25YZR3D1			D1	1772 ~
	5700	SPHWWAHDND25YZQ3H6	YZ	Q3	H6	1684 ~
		SPHWWAHDND25YZQ3D1			D1	1772 ~
6500	SPHWWAHDND25YZP3H6	YZ	P3	H6	1659 ~	
	SPHWWAHDND25YZP3D1			D1	1746 ~	

CRI (R _a) Min.	Nominal CCT (K)	Product Code	V _F Rank	Color Rank	Flux Rank	Flux Range (Φ _v , lm)
90	2700	SPHWAHDND27YZW2H2	YZ	W2	H2	1291 ~
		SPHWAHDND27YZW3H2		W3		
		SPHWAHDND27YZW2D1		W2	D1	1359 ~
		SPHWAHDND27YZW3D2		W3		
	3000	SPHWAHDND27YZV2H3	YZ	V2	H3	1352 ~
		SPHWAHDND27YZV3H3		V3		
		SPHWAHDND27YZV2D1		V2	D1	1423 ~
		SPHWAHDND27YZV3D1		V3		
	3500	SPHWAHDND27YZU2H4	YZ	U2	H4	1400 ~
		SPHWAHDND27YZU3H4		U3		
		SPHWAHDND27YZU2D1		U2	D1	1473 ~
		SPHWAHDND27YZU3D1		U3		
	4000	SPHWAHDND27YZT2H4	YZ	T2	H4	1429 ~
		SPHWAHDND27YZT3H4		T3		
		SPHWAHDND27YZT2D1		T2	D1	1505 ~
		SPHWAHDND27YZT3D1		T3		
	5000	SPHWAHDND27YZR3H4	YZ	R3	H4	1433 ~
		SPHWAHDND27YZR3D1		R3	D1	1508 ~

b) Chromaticity Region & Coordinates ($I_F = 360 \text{ mA}$, $T_J = 85 \text{ }^\circ\text{C}$)



MacAdam Ellipse (W2, W3)					
Step	CIE x	CIE y	θ	a	b
2-step	0.4578	0.4101	53.70	0.0054	0.0028
3-step	0.4578	0.4101	53.70	0.0081	0.0042

MacAdam Ellipse (V2, V3)					
Step	CIE x	CIE y	θ	a	b
2-step	0.4338	0.403	53.22	0.0056	0.0027
3-step	0.4338	0.4030	53.22	0.0083	0.0041

MacAdam Ellipse (U2, U3)					
Step	CIE x	CIE y	θ	a	b
2-step	0.4073	0.3917	54.00	0.0062	0.0028
3-step	0.4073	0.3917	54.00	0.0093	0.0041

MacAdam Ellipse (T2, T3)					
Step	CIE x	CIE y	θ	a	b
2-step	0.3818	0.3797	53.72	0.0063	0.0027
3-step	0.3818	0.3797	53.72	0.0094	0.0040

MacAdam Ellipse (R3)					
Step	CIE x	CIE y	θ	a	b
3-step	0.3447	0.3553	59.62	0.0082	0.0035

MacAdam Ellipse (Q3)					
Step	CIE x	CIE y	θ	a	b
3-step	0.3287	0.3417	59.0950	0.0075	0.0032

MacAdam Ellipse (P3)					
Step	CIE x	CIE y	θ	a	b
3-step	0.3123	0.3282	58.5700	0.0067	0.0029

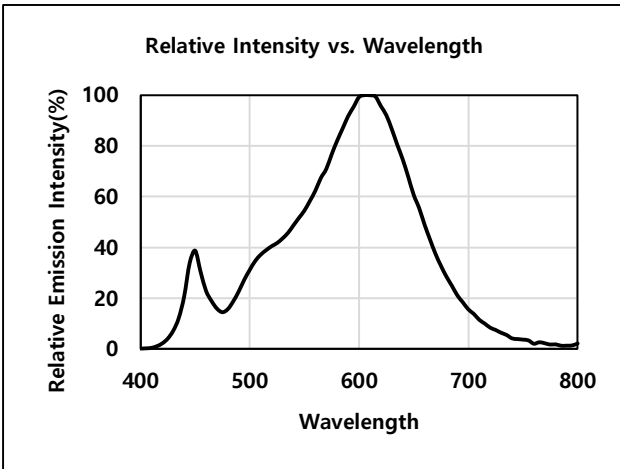
Note:

Samsung maintains measurement tolerance of: $C_x, C_y = \pm 0.005$

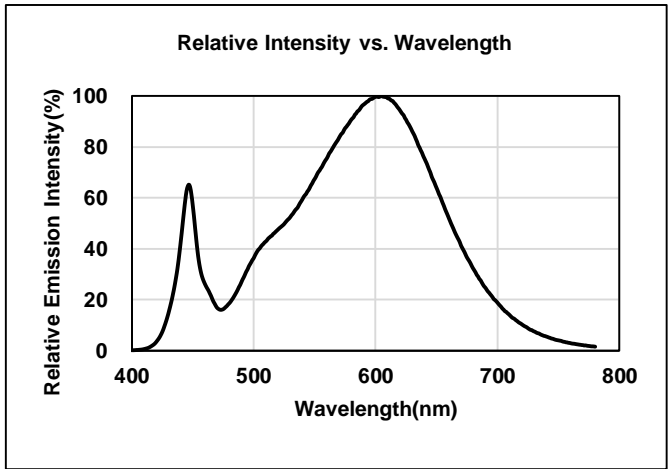
3. Typical Characteristics Graphs

a) Spectrum Distribution ($I_F = 360$, $T_J = 85^\circ\text{C}$)

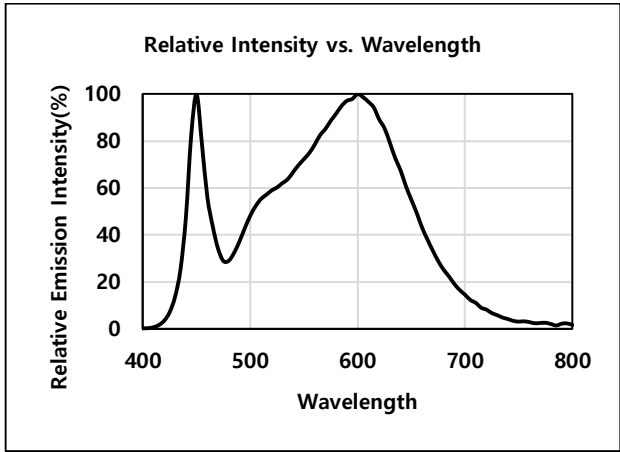
CCT: 2700 K (80 CRI)



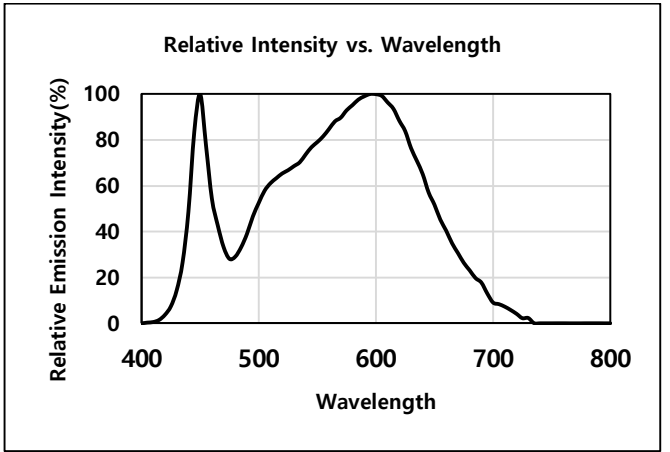
CCT: 3000 K (80 CRI)



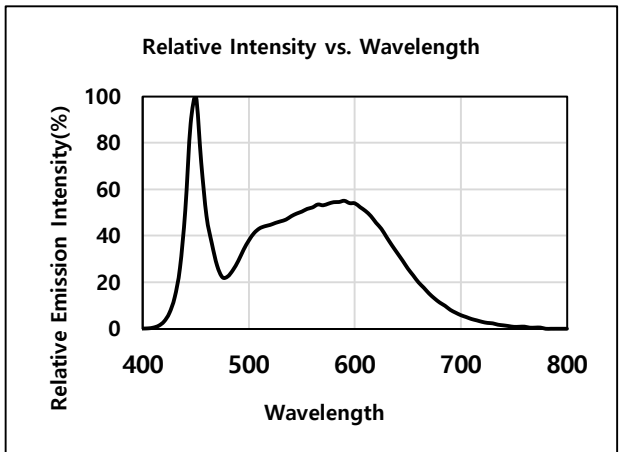
CCT: 3500 K (80 CRI)



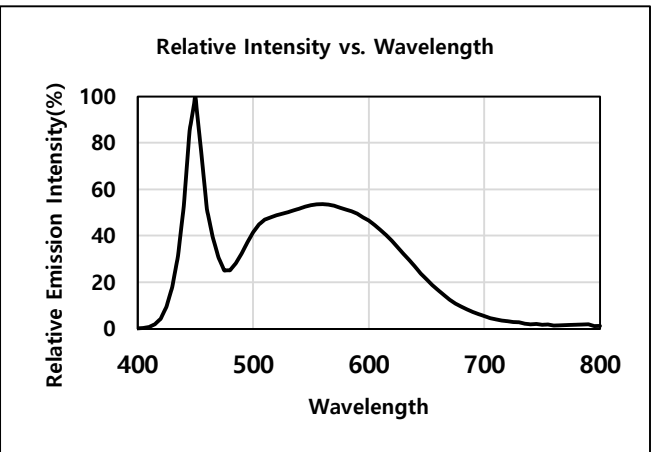
CCT: 4000 K (80 CRI)



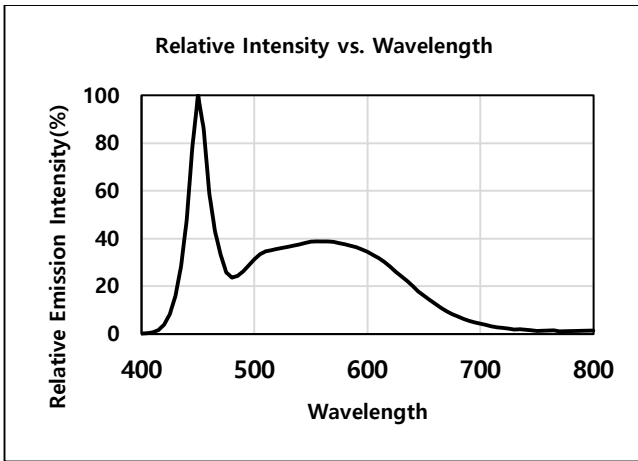
CCT: 5000 K (80 CRI)



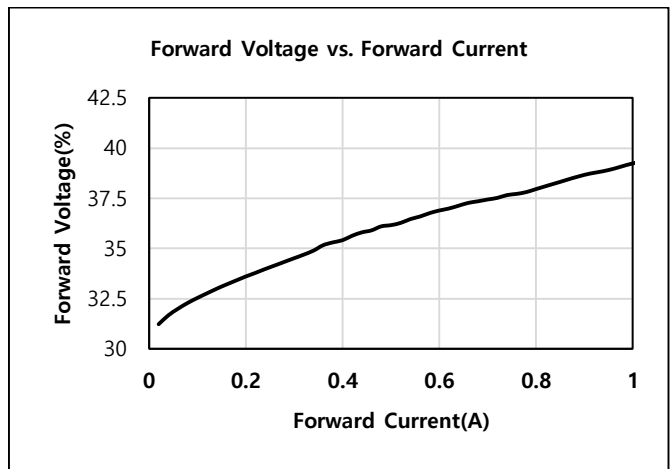
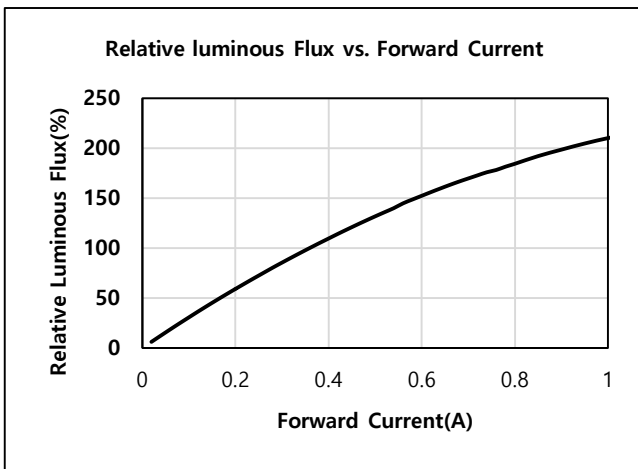
CCT: 5700 K (80 CRI)



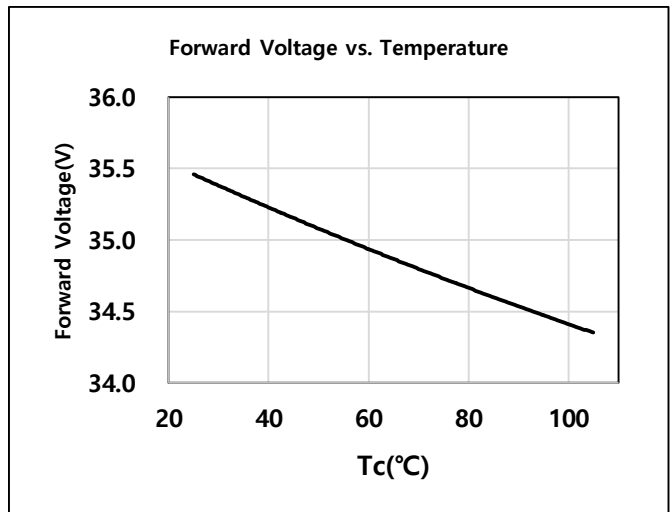
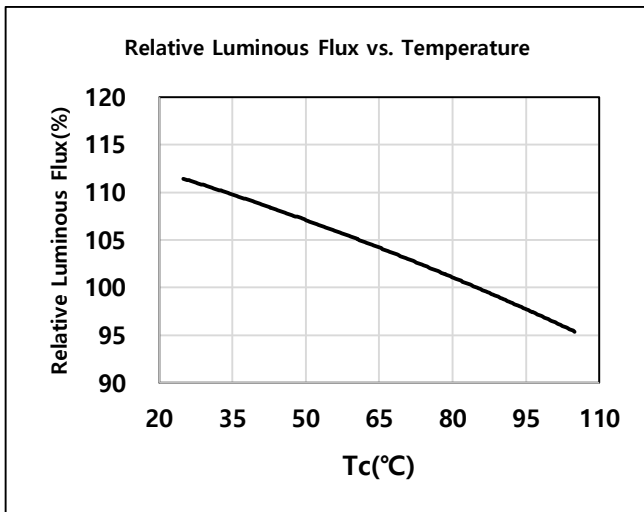
CCT: 6500 K (80 CRI)



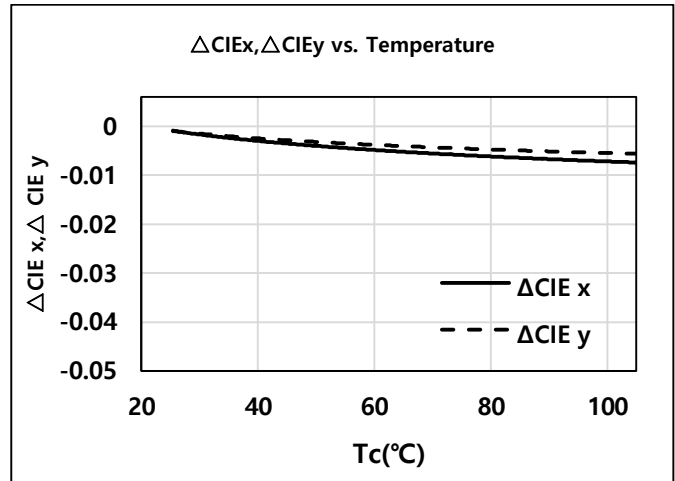
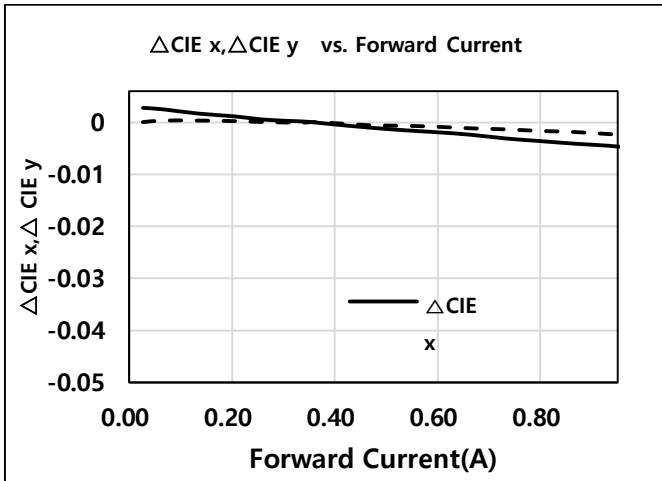
b) Forward Current Characteristics ($T_J = 85^\circ\text{C}$)



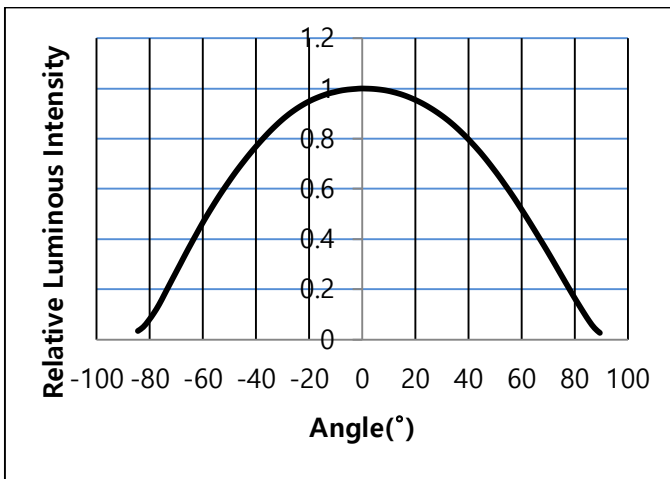
c) Temperature Characteristics ($I_F = 360\text{mA}$)



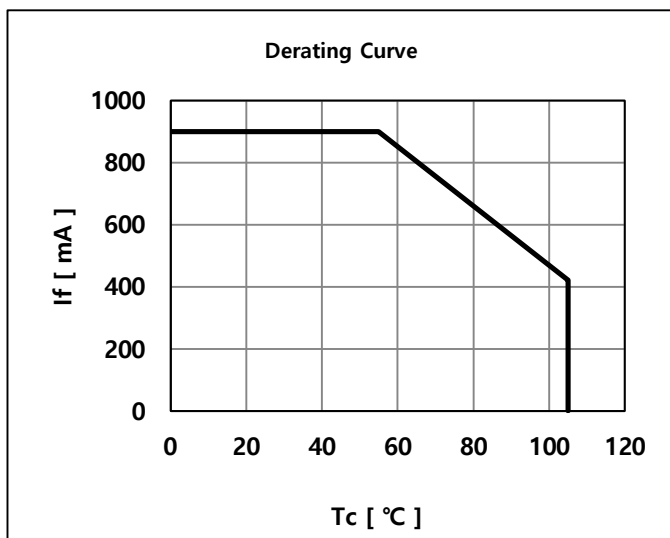
d) Color Shift Characteristics ($T_J = 25\text{ }^\circ\text{C}$, $I_F = 360\text{mA}$, CRI80+)



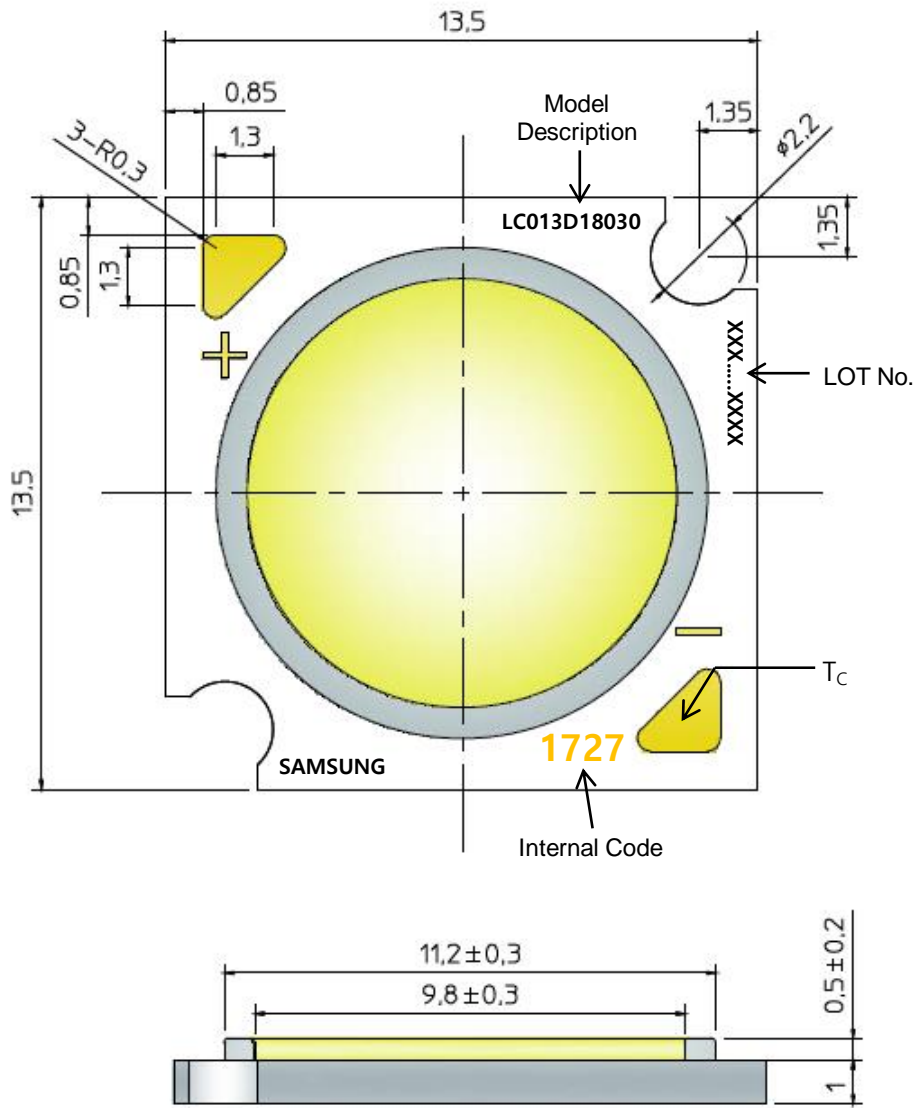
e) Beam Angle Characteristics ($I_F = 360\text{ mA}$, $T_a = 25\text{ }^\circ\text{C}$)



f) Derating Characteristics



4. Outline Drawing & Dimension



- 1. Unit: mm
- 2. Tolerance: ± 0.30 mm

Item	Dimension	Tolerance	Unit
Length	13.5	±0.15	mm
Width	13.5	±0.15	mm
Height	1.50	±0.20	mm
Light Emitting Surface (LES) Diameter	9.8	±0.30	mm

Note: Denoted product information above is only an example
 (LC013D18030 : LC013D, CRI80+, 3000K)

5. Reliability Test Items & Conditions

a) Test Items

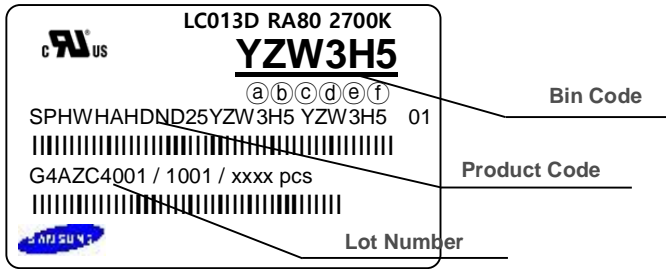
Test Item	Test Condition	Test Hour / Cycle
High Temperature Humidity Life Test	60 °C, 90 % RH,, DC Derating, I _F	1000 h
High Temperature Life Test	85 °C, DC Derating, I _F	1000 h
Low Temperature Life Test	-40 °C, DC , I _F = 700 mA	1000 h
Pulsed Operating Life Test	55 °C, Pulse width 100 μs, duty cycle 3 %	1000 h
High Temperature Storage	120 °C	1000 h
Low Temperature Storage	-40 °C	1000 h
Temperature Humidity Storage	60 °C, 90% RH	1000h
Temperature Cycle On/Off Test	-40 °C / 85 °C each 20 min, 30 min transfer power on/off each 5 min, DC Derating, I _F = max	100 cycles
ESD (HBM)	R ₁ : 10 MΩ R ₂ : 1.5 kΩ C: 100 pF V: ±2 kV	5 times
ESD (MM)	R ₁ : 10 MΩ R ₂ : 0 kΩ C: 200 pF V: ±0.2 kV	5 times
Vibration Test	20 ~ 80 Hz (displacement: 0.06 inch, max. 20 g) 80 ~ 2 kHz (max. 20 g) min. frequency ↔ max. frequency 4 min transfer	4 times
Mechanical Shock Test	1500 g, 0.5 ms each of the 6 surfaces (3 axis x 2 sides)	5 times
Sulfur Resistance	25 °C, 75%, H2S 15 ppm	504h

b) Criteria for Judging the Damage

Item	Symbol	Test Condition (T _c = 25 °C)	Limit	
			Min.	Max.
Forward Voltage	V _F	I _F = 360 mA	L.S.L. * 0.9	U.S.L. * 1.1
Luminous Flux	Φ _v	I _F = 360 mA	L.S.L. * 0.7	U.S.L. * 1.3

6. Label Structure

a) Label Structure



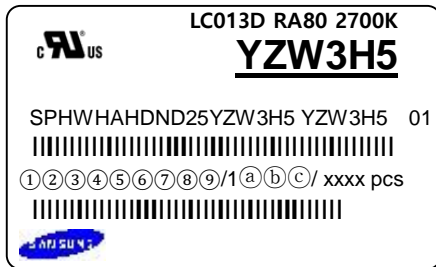
Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

- ⒶⒷ: Forward Voltage bin (refer to page 11)
- ⒸⒹ: Chromaticity bin (refer to page 9-10)
- ⒺⒻ: Luminous Flux bin (refer to page 6)

b) Lot Number

The lot number is composed of the following characters:



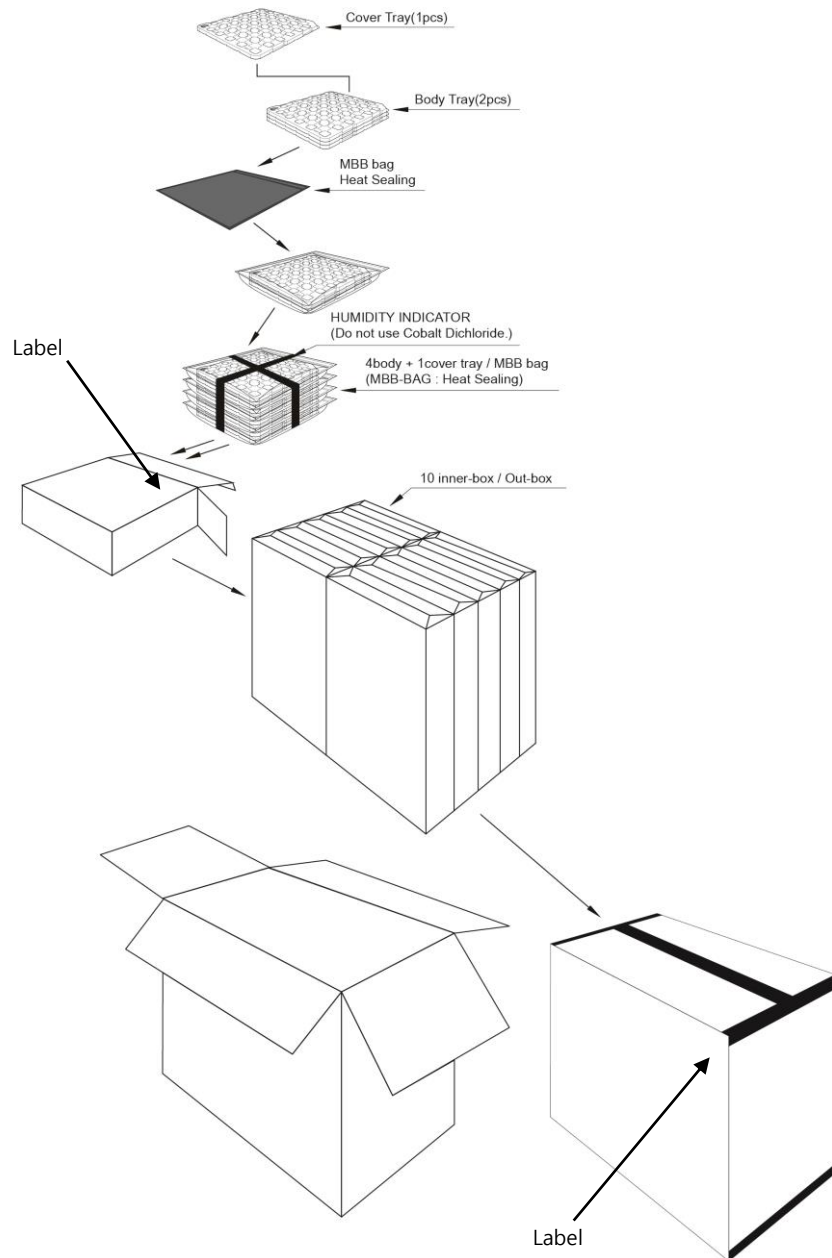
① ③④⑤⑥⑦⑧⑨ / 1ⒶⒷⒸ / xxxx pcs

- ① : Production site (S: Giheung, Korea, G: Tianjin, China)
- ② : 4 (LED)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- ④ : Year (Z: 2015, A: 2016, B: 2017...)
- ⑤ : Month (1~9, A, B, C)
- ⑥⑦⑧⑨ : Day (1~9, A, B~V)
- ⒶⒷⒸ : Product serial number (001 ~ 999)

7. Packing Structure

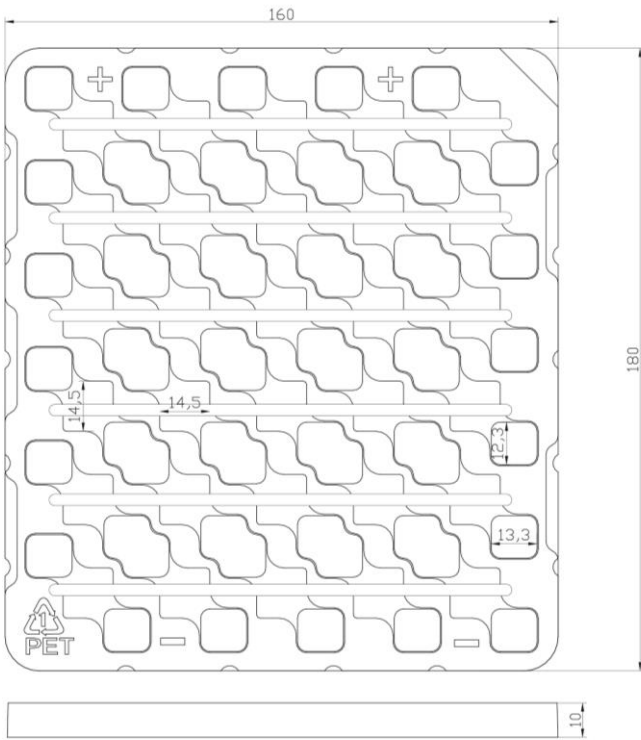
Packing material	Max. quantity in pcs of COB	Dimension(mm)			
		Length	Width	Height	Tolerance
Tray	30	160	180	10	1.0
Aluminum Bag	60(2 trays)	210	241		10
Inner Box	240	230	84	260	2
Outer Box	2400	476	445	272	5

a) Packing Structure

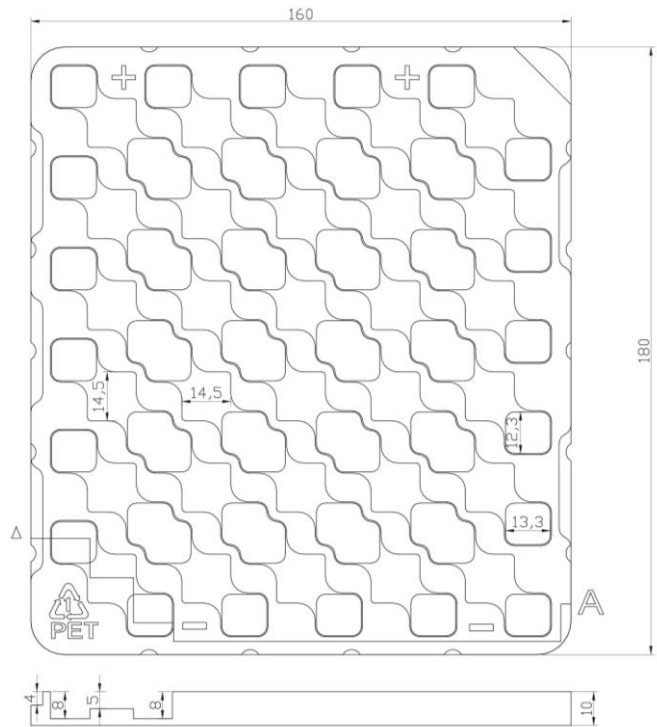


b) Tray

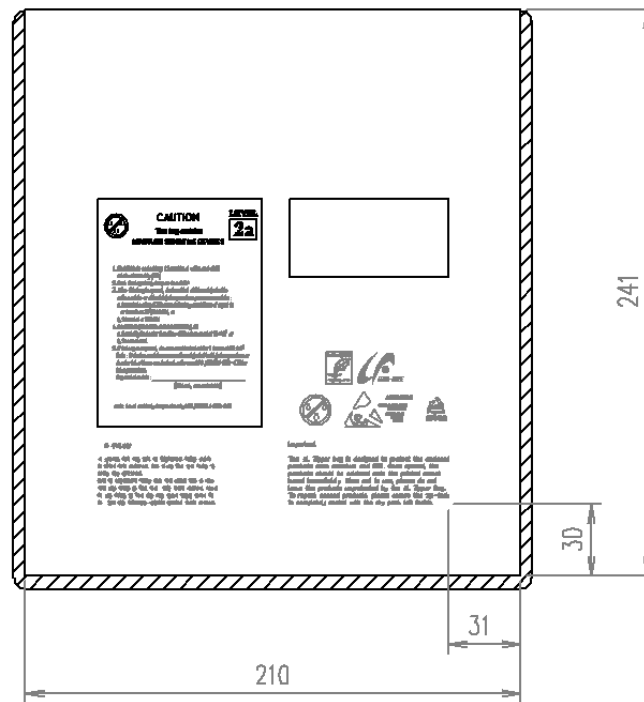
① Cover



② Body

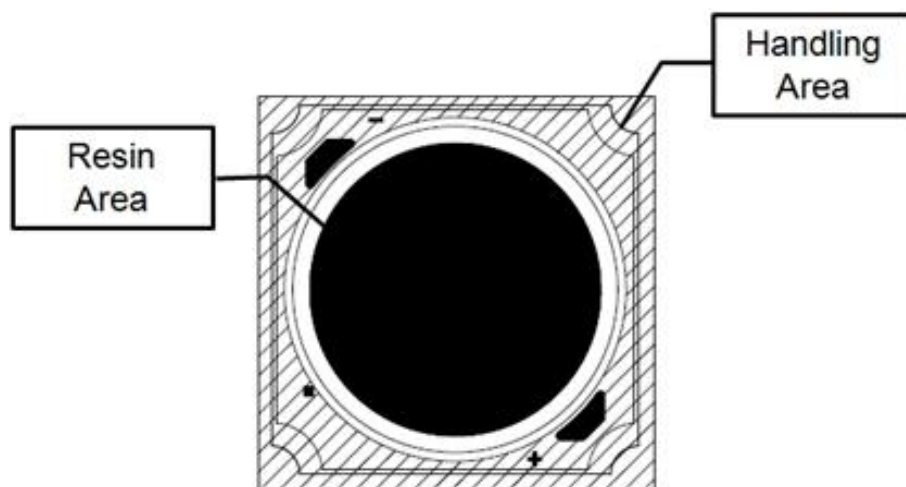


c) Aluminum Vinyl Packing Bag



8. Precautions in Handling & Use

- 1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 2) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 3) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 5) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 6) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.
For more information, please refer to Application Note 'Mechanical & Thermal Guide for COB'.
- 9) In case of driving LEDs around the minimum current level (I_{f_min}), chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) The resin area is very sensitive, please do not handle, press, touch, rub, clean, or pick by with tweezers on it. Instead, please pick at the handling area as indicated below.



Legal and additional information.

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